IPC ASSOCIATION ELECTRONICS	© Copyright 2005.	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.		der both This document level parts	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No. Homogeneous Materi					Informatio	on		
upplier	Information								,					
Company name* Company unique				que ID Un		Unique ID Authority				Response Date*				
nsemi			1								2024-05-04			
Contact Na	me		Title - Contact			Phone - Contact*				Email - Contact*				
Product-Eı	nv-Stewards		Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
uthorized	Representative*		Title - Representative			Phone - Representative*			Email - Representative*					
Product-E	nv-Stewards		Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
	Requester Item Number	Mfr Item	Number	Mfr Item Name		Effective Da	te Versi	on	Manufacturing Site	W	eight*	UOM	Unit Type	
		FPF3380UCX 28V OVP with low o NMOSFET		on-resistance integrated	2024-05-04			РВВ		8594	mg	Each		
	turing Proccess Inform													
1	Terminal Plating / Grid Array Material Terminal Base Alloy J-STI			STD-020 MSL Rating					Temperatu	e Numbe	er of Reflow Cyc	eles		
S	SnAgCu	C	CU Alloy	1		260		C	30	second	3			
omments														
vel 1 - ma	ximum time at peak tempera	ture during sol	dering is 10-3	30 seconds										
or more in	nformation regarding materia	al composition	please refer t	o page 3										

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its uppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreem											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Backside Protection Film	0.0549	mg		Epoxy resin	proprietary data		0.0115	mg
			Supplier	Carbon Black (C)	1333-86-4		0.001	mg
			Supplier	Acrylic resins	Proprietary Data		0.0115	mg
			Supplier	Silica (SiO2)	14464-46-1		0.0309	mg
Die	2.0737	mg	Supplier	Silicon (Si)	7440-21-3		2.0623	mg
			Supplier	Aluminum (Al)	7429-90-5		0.0114	mg
Solder Ball	0.73	mg	Supplier	Silver (Ag)	7440-22-4		0.0412	mg
			Supplier	Tin (Sn)	7440-31-5		0.6844	mg
			Supplier	Copper (Cu)	7440-50-8		0.0044	mg
Under Bump Metal	8.0E-4	mg	Supplier	Titanium (Ti)	7440-32-6		0.0002	mg
			Supplier	Copper (Cu)	7440-50-8		0.0006	mg